

GSM3112ASF

30V N-Channel MOSFET

Product Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

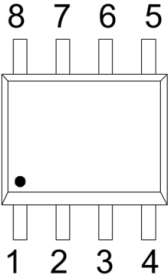
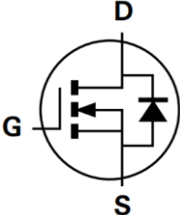
Features

- $R_{DS(ON)} = 11\text{ m}\Omega @ V_{GS}=10\text{V}$
- $R_{DS(ON)} = 16\text{ m}\Omega @ V_{GS}=4.5\text{V}$
- SOP-8L Package
- RoHS Compliant and Halogen Free

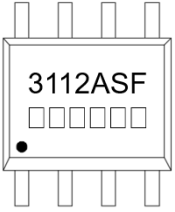
Applications

- Load Switch
- POL Applications
- SMPS

Packages & Pin Assignments

SOP-8L			Equivalent Circuit		
					
Pin	Symbol	Description	Pin	Symbol	Description
1	S	Source	8	D	Drain
2	S	Source	7	D	Drain
3	S	Source	6	D	Drain
4	G	Gate	5	D	Drain

Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Reel
GSM3112ASF	SOP-8L	3112ASF □□□□□□	4,000 PCS
GSM3112A 1 2			
- Product Code: GSM3112A		- Package Code: 1 is S for SOP-8L	
- Green Level: 2 is F for RoHS Compliant and Halogen Free			
Marking Information			
		- Product Code: 3112ASF	
		- GS Code: □□□□□□	
		•The dot indicates pin1	

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Continuous Drain Current	T _A =25°C	10
		T _A =70°C	8
I _{DM}	Pulsed Drain Current ¹	40	A
I _{AS}	Single Pulse Avalanche Current, L = 0.5mH ¹	8	A
E _{AS}	Single Pulse Avalanche Energy, L = 0.5mH ¹	32	mJ
P _D	Power Dissipation	T _A =25°C	1.9
		T _A =70°C	1.23
R _{θJA}	Thermal Resistance-Junction to Ambient ²	65	°C/W
T _J	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

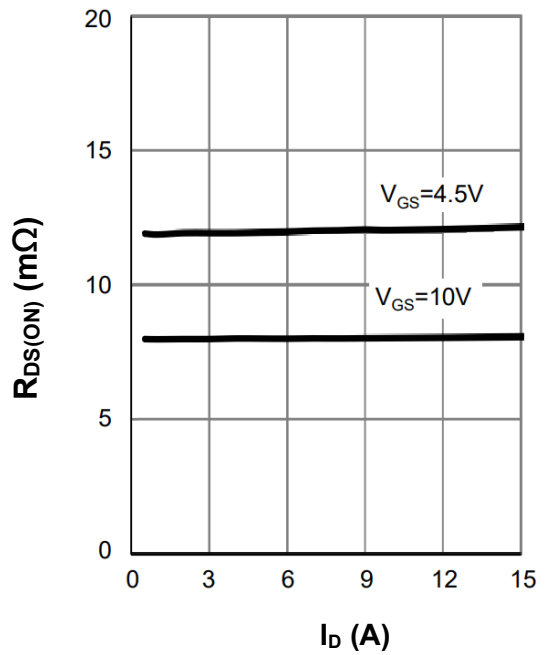
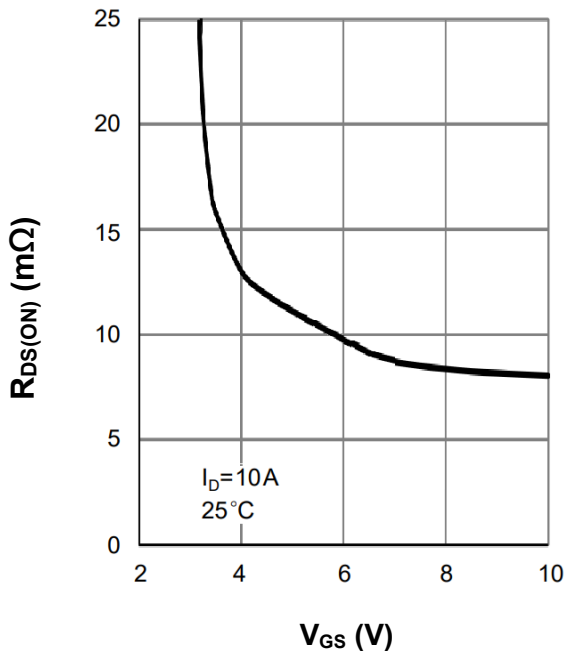
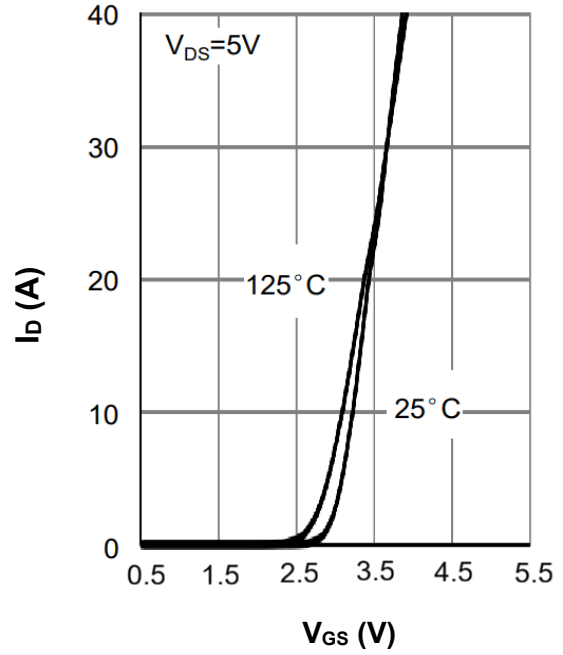
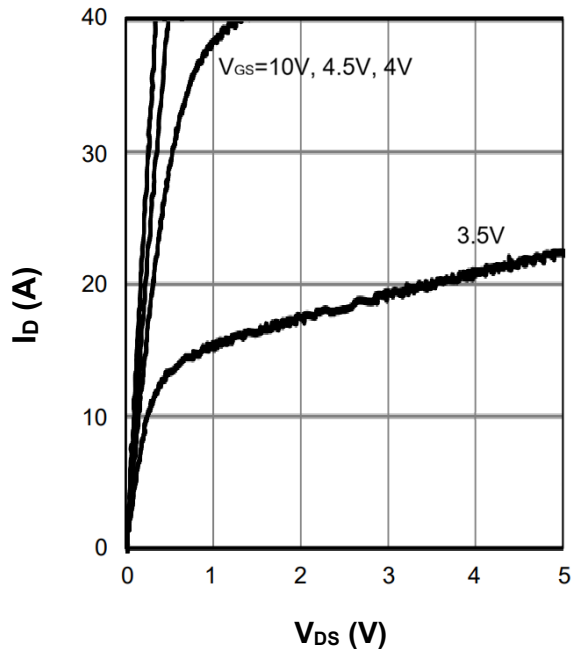
NOTE:

- Single pulse width is limited by max junction temperature.
- The device was mounted on 1in² FR-4 board with 2oz.copper.

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
B _V DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	-	-	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V, V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.2	-	2.5	V
R _{DS(ON)}	Drain-Source On-Resistance	V _{GS} =10V, I _D =10A	-	8	11	mΩ
		V _{GS} =4.5V, I _D =5A	-	12	16	
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =3A	-	7	-	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	-	1420	-	pF
C _{oss}	Output Capacitance		-	150	-	
C _{rss}	Reverse Transfer Capacitance		-	95	-	
Q _g	Total Gate Charge	V _{DS} =15V, I _D =10A V _{GS} =10V	-	22	-	nC
Q _{gs}	Gate-Source Charge		-	4.7	-	
Q _{gd}	Gate-Drain Charge		-	4	-	
t _{d(on)}	Turn-On Delay Time	V _{DD} =15V, I _D =10A V _{GS} =10V, R _g =6Ω	-	12	-	ns
t _r	Turn-On Rise Time		-	15	-	
t _{d(off)}	Turn-Off Delay Time		-	28	-	
t _f	Turn-Off Fall Time		-	15	-	
Diode Characteristics						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1A	-	-	1	V
t _{rr}	Reverse Recovery Time	I _F =10A, di/dt=100A/μs	-	12	-	ns
Q _{rr}	Reverse Recovery Charge		-	5	-	nC

Typical Performance Characteristics



Typical Performance Characteristics

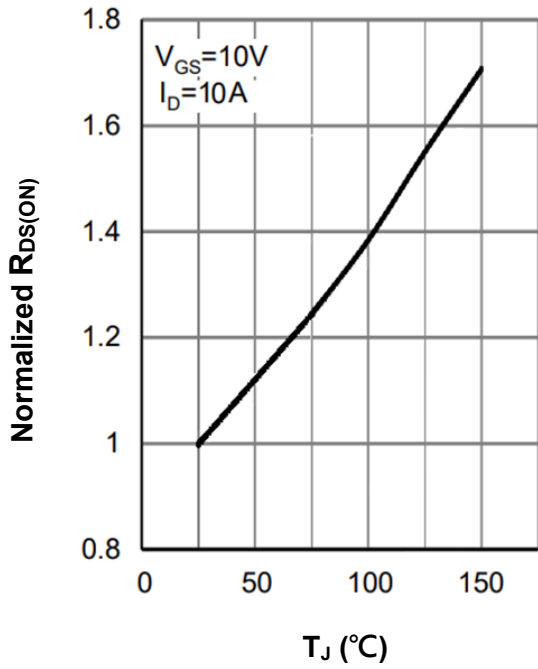


FIG.5 Normalized On-Resistance vs. T_J

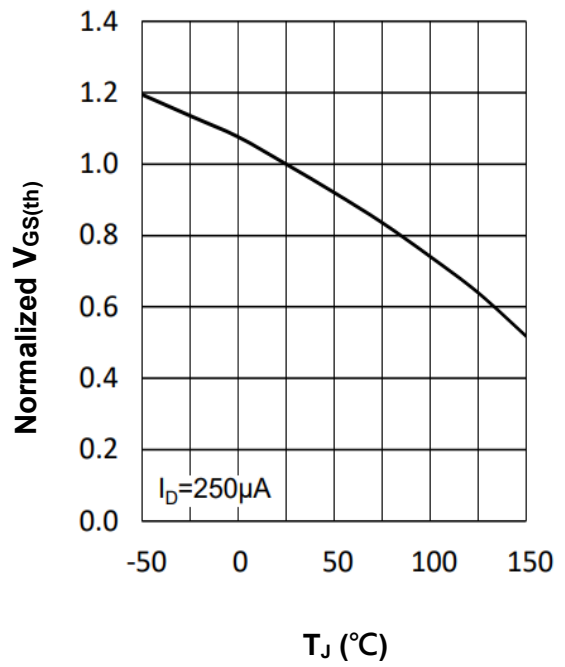


FIG.6 Normalized $V_{GS(th)}$ vs. T_J

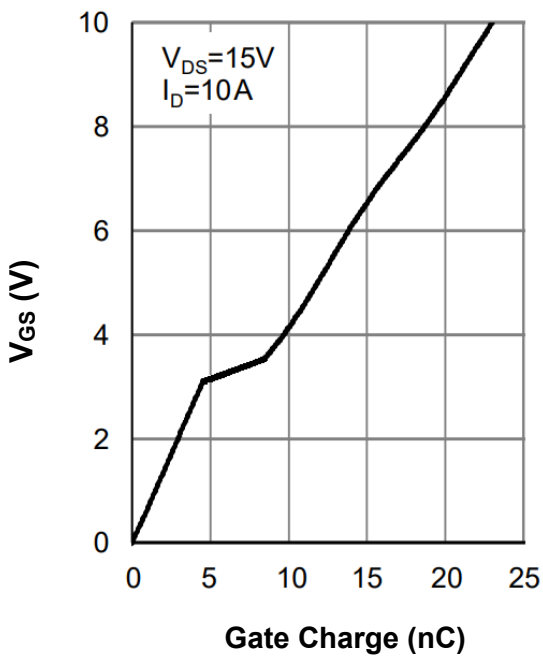


FIG.7 Gate Charge Characteristics

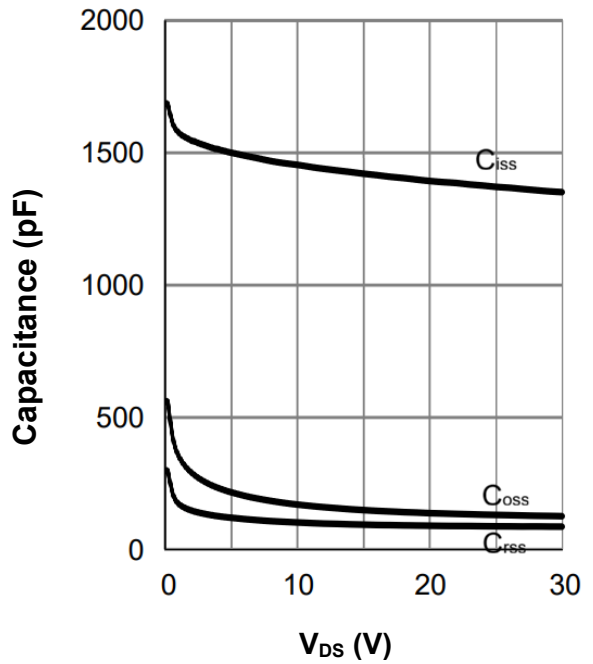


FIG.8 Capacitance Characteristics

Typical Performance Characteristics

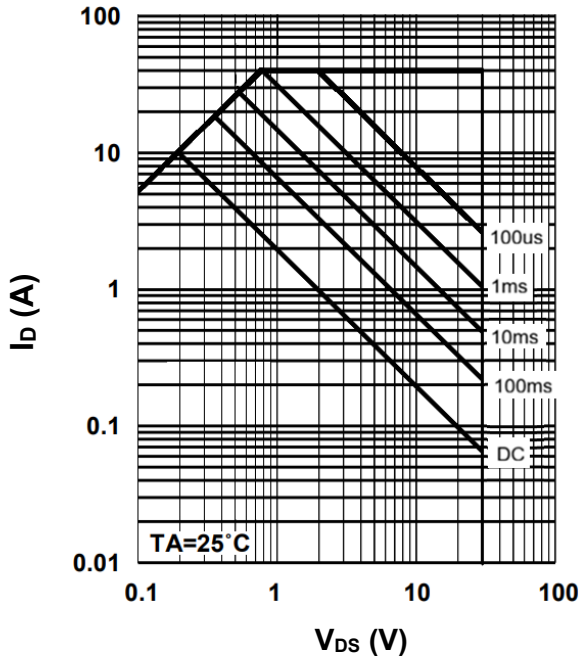


FIG.9 Maximum Safe Operation Area

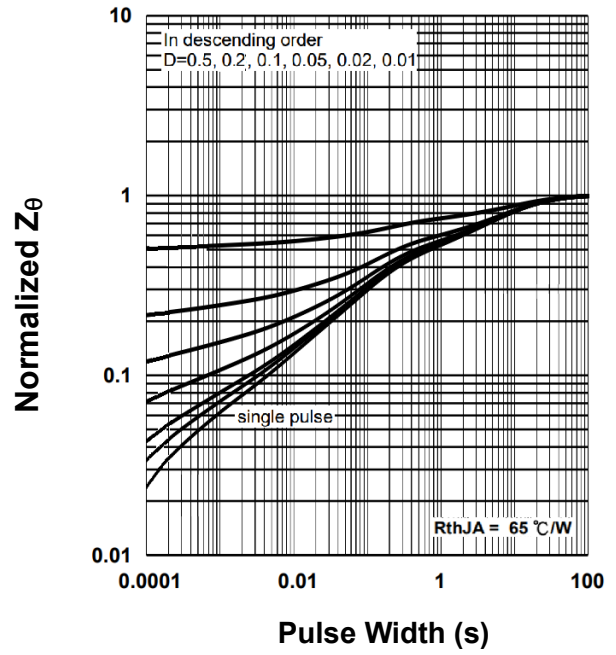
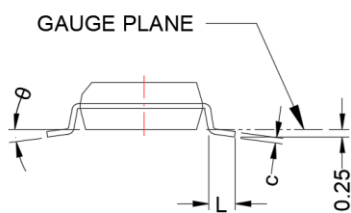
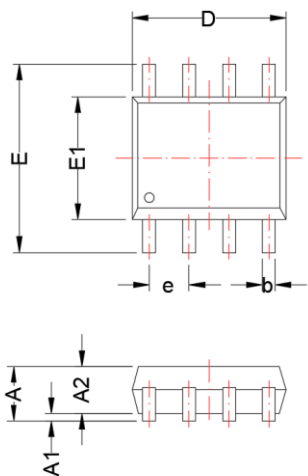


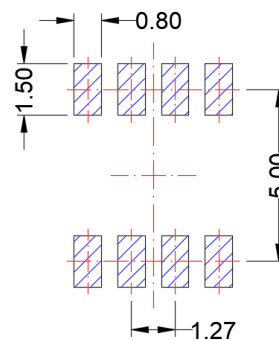
FIG.10 Normalized Transient Impedance

SOP-8L

Package Dimension



Recommended Land Pattern



Unit:mm

Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	---	1.75	---	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	---	0.049	---
b	0.31	0.51	0.012	0.020
c	0.10	0.25	0.004	0.010
D	4.70	5.10	0.185	0.201
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°





NOTE:



Dimensions are exclusive of Burrs, Mold Flash and Tie Bar extrusions.

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